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Inventor(s) Ishii; Mitsuo et al.

Surveying instrument

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Applicant: Topcon Corporation (Tokyo, JP)

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Description

(1) 1. Surveying instrument

(2) **1.1** : Perspective

(3) **1.2**: Perspective

- (4) **1.3**: Front
- (5) **1.4**: Back
- (6) **1.5** : Top
- (7) **1.6**: Left
- (8) **1.7** : Right
- (9) **1.8**: Bottom
- (10) **1.9**: End view taken along line A-A shown in reproduction **1.3**
- (11) The purpose of the claimed design product: to judge the necessary layout for construction by emitting a laser.
- (12) The broken lines shown are included for the purpose of illustrating portions of the surveying instrument and form no part of the claimed design.

Claims

The ornamental design for a surveying instrument as shown and described.